TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (L^2 - π -MOSV)

2SK2399

Chopper Regulator, DC/DC Converter and Motor Drive Applications

4 V gate drive

• Low drain-source ON-resistance : $R_{DS(ON)} = 0.17 \Omega \text{ (typ.)}$

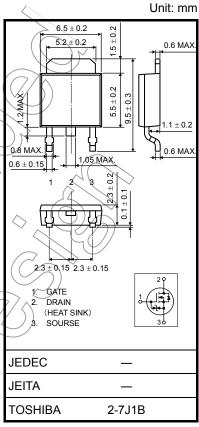
• High forward transfer admittance : $|Y_{fs}| = 4.5 \text{ S (typ.)}$

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 100 V)

• Enhancement mode : $V_{th} = 0.8$ to 2.0 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	100	V	
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	100	V	
Gate-source voltage		V_{GSS}	±20 V		
Drain current	DC (Note 1)	ID	5	Α	
	Pulse (Note 1)	IDP	20	A	
Drain power dissipatio	n (Tc = 25°C)	PD	20	<\\w	
Single-pulse avalanch	e energy (Note 2)	EAS	180	mJ	
Avalanche current		HAR	5 (A	
Repetitive avalanche	energy (Note 3)	(E _{AR})	2	/wJ	
Channel temperature	(Tch	150	(~e)	
Storage temperature r	ange	T _{stg}	-55 to 150	∵ °C	



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic Symbol	Max	Unit
Thermal resistance, channel to case Rth (ch-c)	6.25	°C / W
Thermal resistance, channel to ambient Rth (ch-a)	125	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 11.6 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

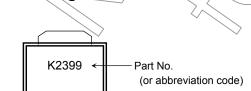
This transistor is an electrostatic-sensitive device. Handle with care.

Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cutoff curr	rent	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON-resistance		R _{DS (ON)}	V _{GS} = 4 V, I _D = 2.5 A		0.22	0.30	Ω
			V _{GS} = 10 V, I _D = 2.5 A	<u> </u>	0.17	0.23	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5	_	S
Input capacitance		C _{iss}			500	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	` —	80	_	pF
Output capacitance		Coss		_	190	_	
Switching time	Rise time	t _r	V _{GS} _{ov} I _D =2.5A OVOUT	- (17	>	
	Turn-on time	t _{on}	RL		25) –	
	Fall time	t _f		7	50	_	ns
	Turn-off time	t _{off}	$V_{DD} = 50V$ $Duty \le 1\%, t_{W} = 10\mu s$) -	195	_	
Total gate charg plus gate-drain)		Qg		_	22		
Gate-source charge		Q _{gs}	$V_{DD} \approx 80 \text{ V}, V_{GS} = 10 \text{ V}, V_{D} = 5 \text{ A}$	_	15	_	nC
Gate-drain ("Miller") charge		Q _{gd}		_	7	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	10R	<u> </u>	_	_	5	Α
Pulse drain reverse current (Note 1)	IDRP	_	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V, dI _{DR} / dt = 50 A / µs	ı	160	1	ns
Reverse recovery charge	Qrr	- IDR - 5 A, VGS - 0 V, αIDR / αι - 50 A / μs	_	0.28	_	μC



Lot No.

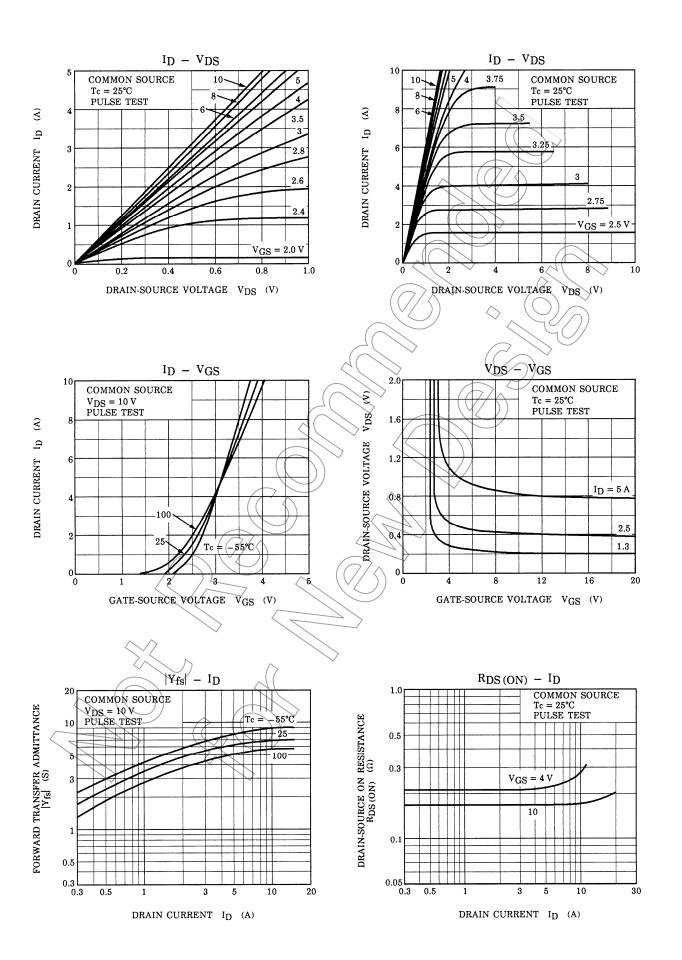
Note 4

Marking

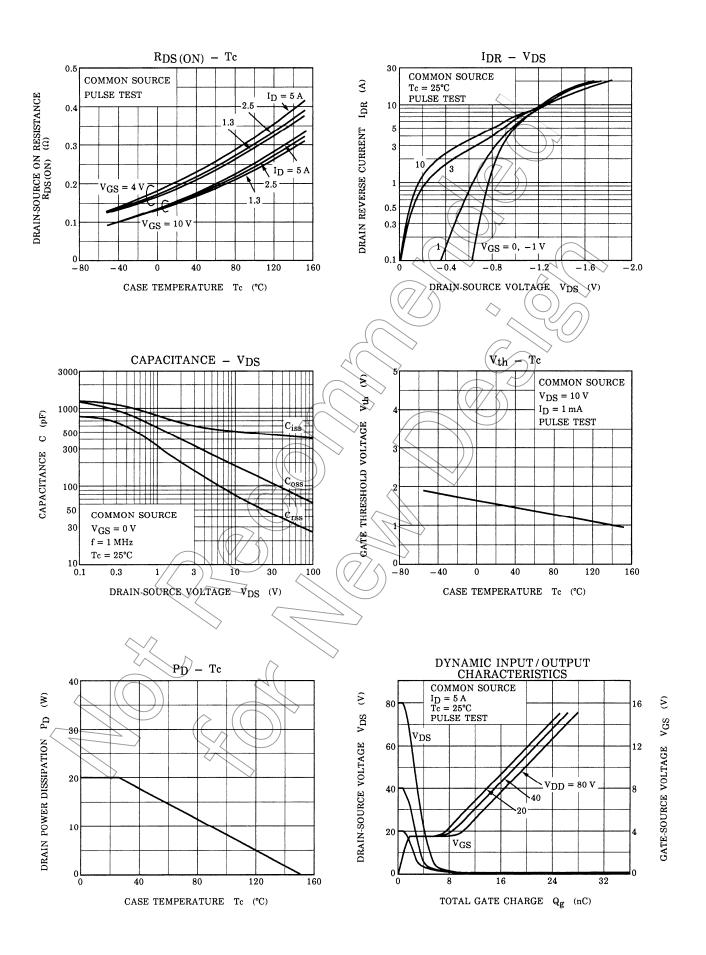
Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

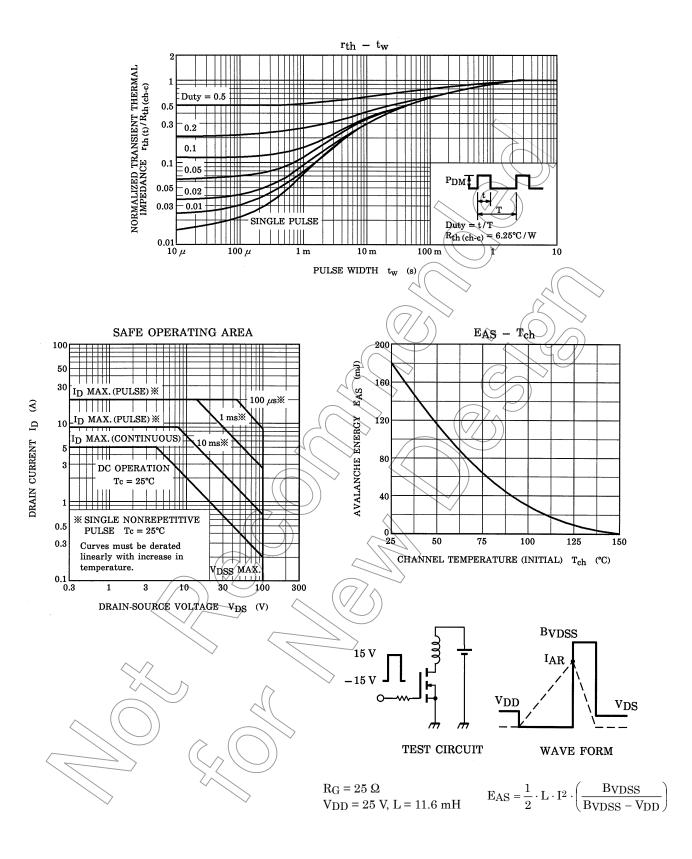
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